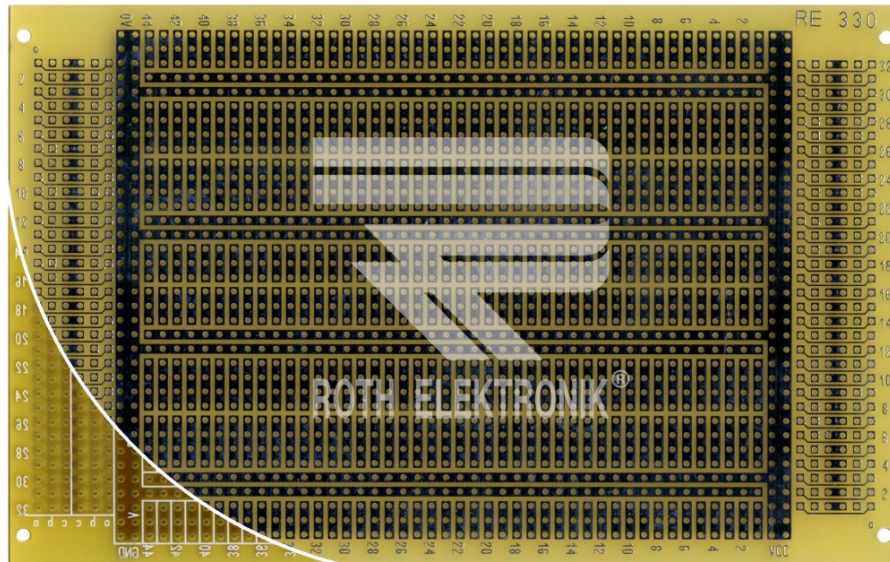


Prototyping Board



RE330-LF

- EPOXY fibre-glass FR4 1.5 mm single-sided 35 µm CU
- hot air leveling (HAL-leadfree)
- 36 x 44 single-hole conductor
- hole spacing 2.54 x 2.54 mm
- hole dia 1.0 mm
- 2 x connector 32/64/96-channel
- DIN 41612 type C
- with additional print on component side
- size 100 x 160 mm